

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
STATIC ELECTRICAL RATINGS						
BV_{DSS}	Drain – Source Breakdown Voltage	$V_{GS} = 0$	$I_D = 1\text{mA}$	200	V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	Reference to 25°C $I_D = 1\text{mA}$		0.28	$\text{V}/^\circ\text{C}$	
$R_{DS(on)}$	Static Drain – Source On–State Resistance ²	$V_{GS} = 10\text{V}$	$I_D = 17\text{A}$		0.100	Ω
		$V_{GS} = 10\text{V}$	$I_D = 27.4\text{A}$		0.105	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 250\mu\text{A}$	2	4	V
g_{fs}	Forward Transconductance ²	$V_{DS} \geq 15\text{V}$	$I_{DS} = 17\text{A}$	9		$\text{S}(\overline{\tau})$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0$	$V_{DS} = 0.8BV_{DSS}$		25	μA
			$T_J = 125^\circ\text{C}$		250	
I_{GSS}	Forward Gate – Source Leakage	$V_{GS} = 20\text{V}$			100	nA
I_{GSS}	Reverse Gate – Source Leakage	$V_{GS} = -20\text{V}$			-100	
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	$V_{GS} = 0$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$		3500		pF
C_{oss}	Output Capacitance			700		
C_{rss}	Reverse Transfer Capacitance			110		
C_{DC}	Drain – Case Capacitance			12		
Q_g	Total Gate Charge	$V_{GS} = 10\text{V}$		55	115	nC
Q_{gs}	Gate – Source Charge	$I_D = 27.4\text{A}$		8	22	
Q_{gd}	Gate – Drain (“Miller”) Charge	$V_{DS} = 0.5BV_{DSS}$		30	60	
$t_{d(on)}$	Turn– On Delay Time	$V_{DD} = 100\text{V}$ $I_D = 27.4\text{A}$ $R_G = 2.35\Omega$	$V_{gs} = 10\text{V}$		35	ns
t_r	Rise Time				190	
$t_{d(off)}$	Turn–Off Delay Time				170	
t_f	Fall Time				130	
SOURCE – DRAIN DIODE CHARACTERISTICS						
I_S	Continuous Source Current				27.4	A
I_{SM}	Pulse Source Current ¹				110	
V_{SD}	Diode Forward Voltage ²	$I_S = 27.4\text{A}$	$T_J = 25^\circ\text{C}$		1.9	V
t_{rr}	Reverse Recovery Time ²	$I_F = 27.4\text{A}$	$T_J = 25^\circ\text{C}$		950	ns
Q_{rr}	Reverse Recovery Charge ²	$d_i / d_t \leq 100\text{A}/\mu\text{s}$ $V_{DD} \leq 50\text{V}$			9.0	μC
t_{on}	Forward Turn–On Time	Negligible				
PACKAGE CHARACTERISTICS						
L_D	Internal Drain Inductance	Measured from 6mm down drain lead to centre of die			8.7	nH
L_S	Internal Source Inductance	Measured from 6mm down source lead to source bond pad			8.7	

1) Repetitive Rating – Pulse width limited by Maximum Junction Temperature

2) Pulse Test: Pulse Width $\leq 300\mu\text{s}$, $\delta \leq 2\%$.

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